

## §5. Research and Development of New Intermetallic Compound Superconductors

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Generation of high magnetic field in superconducting state is required in the development of fusion, NMR and other advanced facilities. Present author has revealed that a Sn-Ta alloy with ductility can be prepared by melting a mixture of Sn+Ta powder when the Ta concentration is between 25~30at%<sup>1)</sup>. In the present study, new (Nb,Ta)<sub>3</sub>Sn conductors have been fabricated through Jelly Roll(JR) and filamentary process using ductile Sn-Ta or Sn-Ta-Cu matrix. No intermediate annealing is required for the fabrication, and thick and uniform (Nb,Ta)<sub>3</sub>Sn layers are synthesized after the reaction. Ta in the Sn-Ta sheet is incorporated into the Nb<sub>3</sub>Sn layer, improving the high-field performance of Nb<sub>3</sub>Sn.

In the present study, Sn-Ta alloy with Sn/Ta ratio of 7/3 and 3/1 with or without 2.5wt% and 5wt%Cu addition were melted at 800°C for 10h in vacuum. The melted Sn-Ta button, typically 50gr. in weight, was pressed into a plate and flat rolled into a sheet 100μm in thickness. In the JR process the Sn-Ta or Sn-Ta-Cu sheet was laminated with a Nb sheet of the same thickness, and wound around a Nb-4at%Ta rod. In the filamentary process, the Sn-Ta or Sn-Ta-Cu sheet was wound around thirteen Nb-1at%Ta rod(core) and wrapped around 13 components. The resulting JR or filamentary composite was encased in a Nb-4at%Ta tube and then fabricated into a wire 1.40mm in diameter. The resulting wires were heat treated at 775°C - 900°C for 80hr in vacuum.

The EDX composition mapping of the Sn-Ta-Cu sheet with a Sn/Ta ratio of 7/3 and 2.5wt%Cu addition is composed of a matrix with a dispersion of white and black particles 1-10μm in diameter. The matrix is Sn containing a small amount of Ta and Cu. The white particle is based on Ta, the approximate composition being Ta<sub>3</sub>(Sn<sub>0.7</sub>Cu<sub>0.3</sub>). The black particle is richer in Cu of which composition corresponds roughly to Cu<sub>2</sub>Sn containing a small amount of Ta. The Sn-Ta-Cu alloys with such a macrostructure have an appropriate workability to be fabricated into a thin sheet.

The 2.5wt%Cu addition and 5wt%Cu addition to the Sn-Ta sheet decreases the optimum heat treatment temperature to 800°C and 775°C, respectively, from 900°C. Transition temperature of the wires is almost independent on the Sn/Ta ratio and amount of Cu addition to the sheet, the midpoint of the transition being ~18.0K.

Fig.1 is the critical current,  $I_c$  and non-Cu critical current density,  $J_c$  versus magnetic field curves of the JR wires. The measurement at 2.1K was made under reduced pressure atmosphere. The 7/3 wire reacted at 900°C for 80h shows a non-Cu  $J_c$  of 100A/mm<sup>2</sup> at 4.2K and 23T, and at 2.1K and 25T. The  $J_c$ -magnetic field curve shifts to higher field by about 2T by reducing the temperature from 4.2K to 2.1K. The upper critical field of the wire reacted at 900°C extrapolated by the Kramer plot reaches 28.5T at 2.1K. The 7/3 JR wire with 2.5wt%Cu addition shows a non-Cu  $J_c$  of 100A/mm<sup>2</sup> at

4.2K and 22T, and at 2.1K and 24T. The present wires exhibit a few Tesla better high-field performance than the bronze-processed (Nb,Ti)<sub>3</sub>Sn wire, as indicated in Fig.1, which is the best commercial high-field superconductor. Furthermore, present wires exhibit fairly large n values, e.g. the 7/3 JR wire shows a n value of 30 at ~23.5T and ~25.7T at 4.2K and 2.1K, respectively. This indicates the potentiality of the present (Nb,Ta)<sub>3</sub>Sn wire in high magnetic fields.

Figs.2 (a) and (b) illustrate cross-sectional configuration of the 13-core filamentary wire, and EPMA composition mapping of the wire after the section at 800°C, respectively. Residual Nb-1at%Ta core(orange) and surrounded thick (Nb,Ta)<sub>3</sub>Sn layer(yellowish green) are observed in Fig.2(b). Some Nb is incorporated into the Sn-Ta matrix. The 13-core filamentary wire with a sheet composition of 7/3+2.5Cu and reacted at 800°C shows nearly the same non-Cu  $J_c$  and n value as those of JR wires in high magnetic fields.

In conclusion, new (Nb,Ta)<sub>3</sub>Sn wire with promising high-field performance have been successfully fabricated through Jelly Roll process and filamentary process using ductile Sn-Ta(-Cu) sheet.

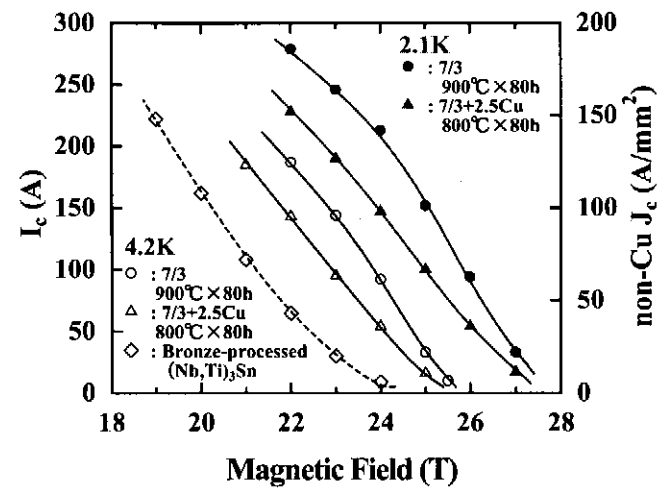


Fig.1  $I_c$  and non-Cu  $J_c$  versus magnetic field curves of JR-processed (Nb,Ta)<sub>3</sub>Sn wires at 4.2K and 2.1K.

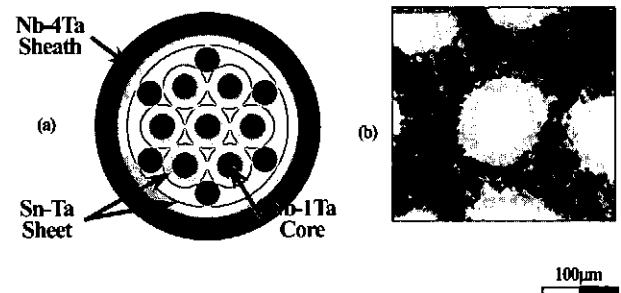


Fig.2 (a) Cross-sectional configuration of 13-core filamentary wire. (b) EPMA composition mapping of the filamentary wire reacted at 800°C for 80h.

### Reference

- 1) Tachikawa, K., Kato, R., Aodai, M., Izawa, H. and Takeuchi, T. : IEEE Trans. Appl. Supercond., Vol13, No2(2003) p.3438-3441.